

## PATENT ASSIGNMENT COVER SHEET

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|---|---------------------------------|-----------------------|
| <b>SUBMISSION TYPE:</b>   | NEW ASSIGNMENT                  |                       |
| <b>NATURE OF CONVEYANCE:</b>  | ASSIGNMENT                      |                       |
| <b>CONVEYING PARTY DATA</b>   |                                 |                       |
|   | <b>Name</b>                     | <b>Execution Date</b> |
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| <b>PROPERTY NUMBERS Total: 1</b>  |                                 |                       |
|   | <b>Property Type</b>            | <b>Number</b>         |
|   | Patent Number:                  | 8291750               |
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| <b>SIGNATURE:</b>   | /TESIEGEL37442/                 |                       |
| <b>DATE SIGNED:</b>   | 02/02/2015                      |                       |
| <b>Total Attachments: 2</b>   |                                 |                       |
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|---|---|
| <b>Assignment of Rights, Title and Interest in Invention<br/>(Patent Owner)</b> | <b>Docket No.:</b><br><br><b>GO1.001.US</b> |
|---|---|

*This is an Assignment of the following rights, title, and interest:*

- *United States of America rights, title and interest in the invention*
- *Foreign rights, title and interest in the invention*

|                           |                                      |                    |                   |
|---------------------------|--------------------------------------|--------------------|-------------------|
| <b>Title of Invention</b> | RESONANT MEASURING SYSTEM AND METHOD |                    |                   |
| <b>App. Ser. No.</b>      | 12/378,534                           | <b>Filing Date</b> | February 17, 2009 |
| <b>Patent</b>             | 8,291,750                            | <b>Issue Date</b>  | October 23, 2012  |

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|  |   |
|--|---|
| <b>Assignment of Rights, Title and Interest in Invention</b><br><b>(Inventor; single assignee)</b> | <b>Docket No.:</b><br><b>GO1.001.US</b> |
|--|---|

*Whereas, I, the above-identified Inventor, has invented certain new and useful improvements in the invention described in the patent application identified by the title shown above (hereinafter referred to as "Invention");*

*And, whereas I desire to assign my above-identified right, title and interest in the Invention to the above-identified Assignee;*


*Now, this indenture witnesseth, that for good and valuable consideration, the receipt whereof is hereby acknowledged;*

*I hereby assign, sell and transfer my above-identified rights, title and interest in said Invention, said application(s) as identified above, including any divisions, continuations, and continuations-in-part thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted or have granted for said Invention, and in and to any and all reissues and reexaminations thereof, and in and to any and all priority rights, Convention rights, and other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, unto said Assignee;*

*And I hereby authorize and request the Director of the United States Patent and Trademark Office to issue any United States Letters Patent which may issue for said Invention to said Assignee, as assignee of the whole right, title and interest thereto;*

*And I further agree to sign and execute all necessary and lawful future documents, including applications for foreign patents, for filing divisions, continuations and continuations-in-part of said application for patent, and/or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid Invention, which the Assignee or its Designee(s) may from time to time require and prepare at its own expense.*

**Inventor's Signature**

| Name             | Signature   | Title | Date     |
|------------------|---|-------|----------|
| Joseph Goodbread |  |       | 1/9/2014 |